

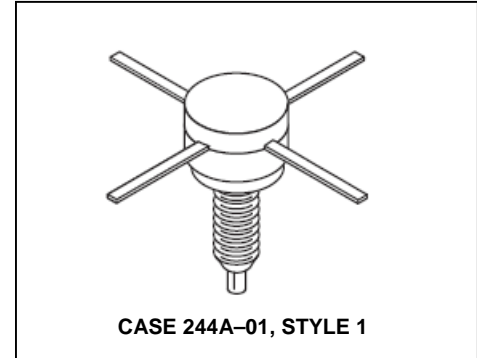
The RF Line NPN Silicon High Frequency Transistor Noise Figure 3.0 dB@ 500MHz

M/A-COM Products
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Designed for use in high-gain, low-noise, ultra-linear, tuned and wide-band amplifiers. Ideal for use in CATV, MATV, and instrumentation applications.

- Low noise figure —
NF = 3.0 dB (typ.) @ f = 500 MHz, I_C = 90 mA
- High power gain —
G_{U(max)} = 16.5 dB (typ.) @ f = 500 MHz
- Ion implanted
- All gold metal system
- High f_T — 5.5 GHz
- Low intermodulation distortion:
TB₃ = -70 dB
DIN = 125 dB μV
- Nichrome emitter ballast resistors

Product Image



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	17	Vdc
Collector-Base Voltage	V _{CBO}	34	Vdc
Emitter-Base Voltage	V _{EBO}	2.5	Vdc
Collector Current — Continuous	I _C	200	mAdc
Total Device Dissipation @ T _C = 50°C Derate above T _C = 50°C	P _D	5.0 33	Watts mW/°C
Storage Temperature Range	T _{stg}	- 65 to +150	°C
Junction Temperature	T _J	200	°C

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (I _C = 5.0 mAdc, I _B = 0)	V _{(BR)CEO}	17	—	—	Vdc
Collector-Base Breakdown Voltage (I _C = 1.0 mAdc, I _E = 0)	V _{(BR)CBO}	34	—	—	Vdc
Emitter-Base Breakdown Voltage (I _C = 0, I _E = 0.1 mAdc)	V _{(BR)EBO}	2.5	—	—	Vdc
Collector Cutoff Current (V _{CB} = 10 Vdc, I _E = 0)	I _{CBO}	—	—	50	μAdc

ON CHARACTERISTICS

DC Current Gain (1) (I _C = 50 mAdc, V _{CE} = 5.0 Vdc)	h _{FE}	50	—	200	—
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NOTE:

1. 300 μs pulse on Tektronix 576 or equivalent.

(continued)

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ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
DYNAMIC CHARACTERISTICS					
Current-Gain — Bandwidth Product (2) (I _C = 90 mA, V _{CE} = 15 Vdc, f = 0.5 GHz)	f _T	—	5.5	—	GHz
Collector-Base Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)	C _{cb}	—	1.7	2.2	pF
FUNCTIONAL TESTS					
Narrowband — Figure 15 (I _C = 90 mA, V _{CC} = 15 V, f = 0.5 GHz) Noise Figure Power Gain at Optimum Noise Figure	NF G _{NF}	— 11	3.0 13	4.0 —	dB
Broadband — Figure 16 (I _C = 90 mA, V _{CC} = 15 V, f = 0.3 GHz) Noise Figure Power Gain at Optimum Noise Figure	NF G _{NF}	— —	6.3 11	— —	dB
Triple Beat Distortion (I _C = 50 mA, V _{CC} = 15 V, P _{Ref} = 50 dBmV) (I _C = 90 mA, V _{CC} = 15 V, P _{Ref} = 50 dBmV)	TB ₃	—	-70	—	dB
DIN 45004 (I _C = 90 mA, V _{CC} = 15 V) (I _C = 90 mA, V _{CC} = 15 V)	DIN	—	125	—	dBμV
Maximum Available Power Gain (3) (I _C = 90 mA, V _{CE} = 15 Vdc, f = 0.5 GHz)	G _{Umax}	—	16.5	—	dB

NOTES:

2. Characterized on HP8542 Automatic Network Analyzer

$$3. G_{Umax} = \frac{|S_{21}|^2}{(1-|S_{11}|^2)(1-|S_{22}|^2)}$$

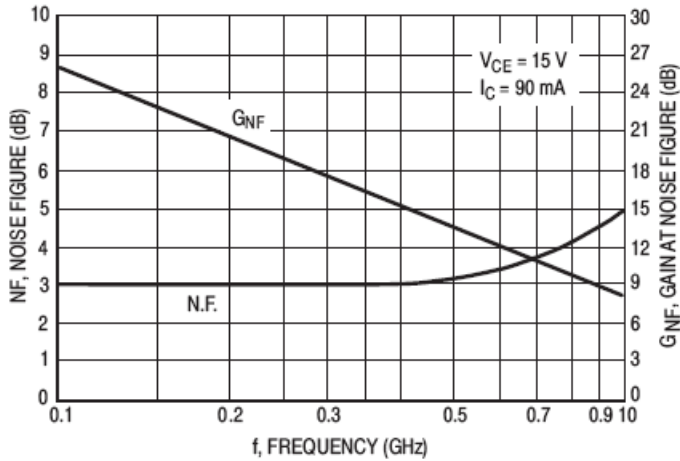


Figure 1. Typical Noise Figure and Associated Gain versus Frequency

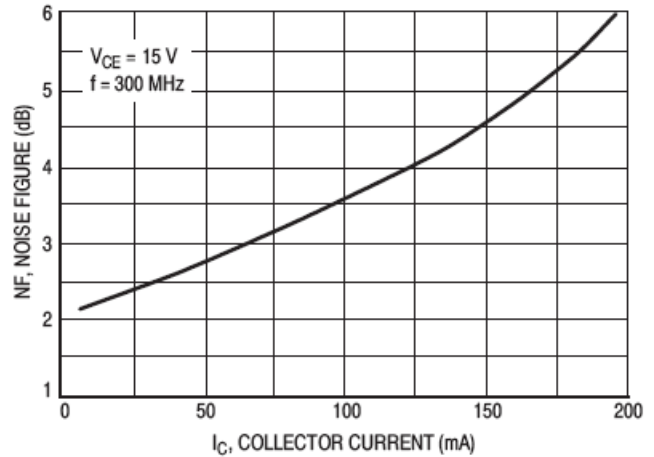


Figure 2. Noise Figure versus Collector Current

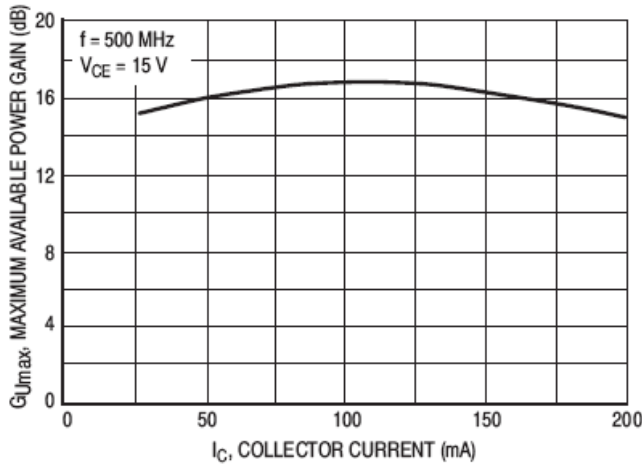


Figure 3. G_{Ummax} versus Collector Current

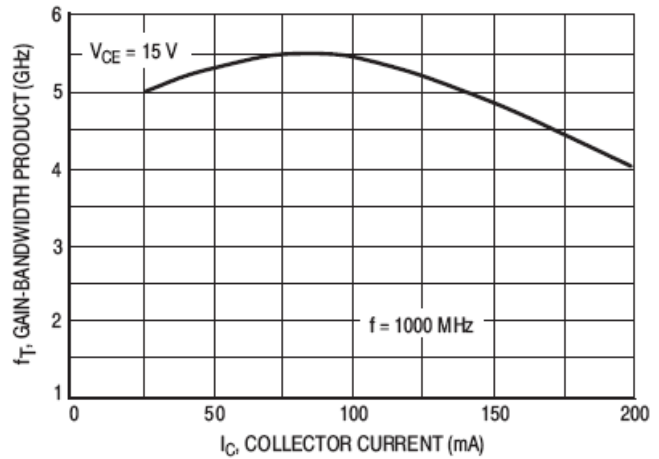


Figure 4. Gain-Bandwidth Product versus Collector Current

TYPICAL PERFORMANCE

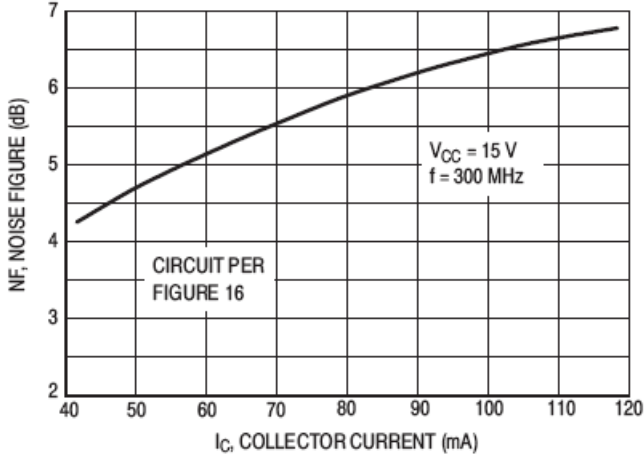


Figure 5. Broadband Noise Figure

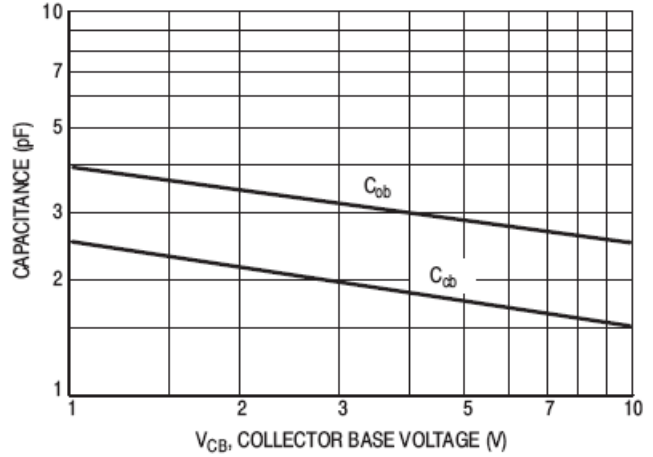


Figure 6. Junction Capacitance versus Voltage

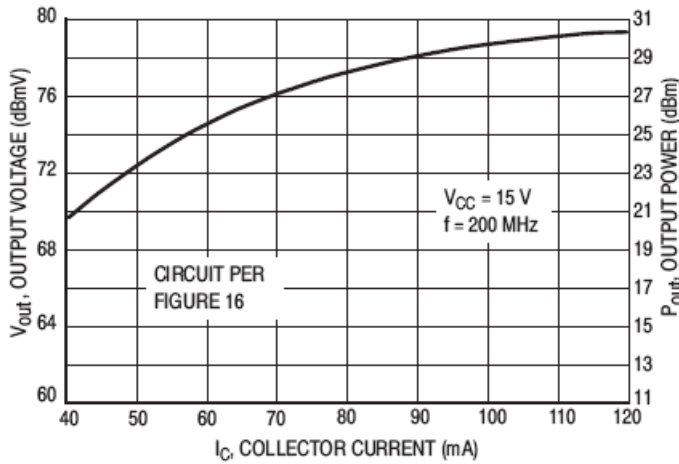


Figure 7. 1.0 dB Compression Point versus Collector Current

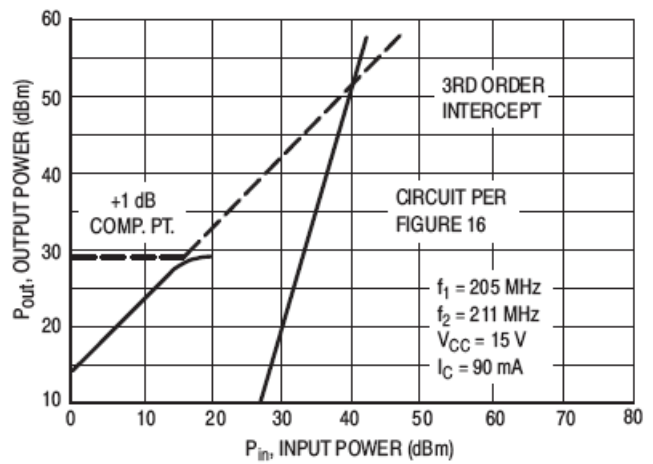


Figure 8. Third Order Intercept Point

TYPICAL PERFORMANCE (continued)

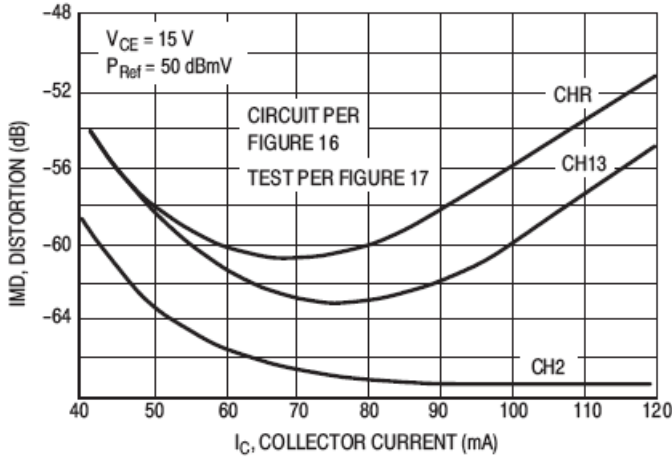


Figure 9. Second Order Distortion versus Collector Current

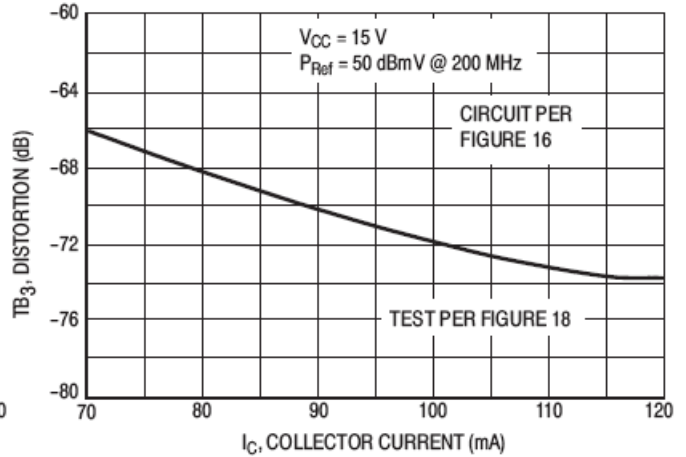


Figure 10. Triple Beat Distortion versus Collector Current

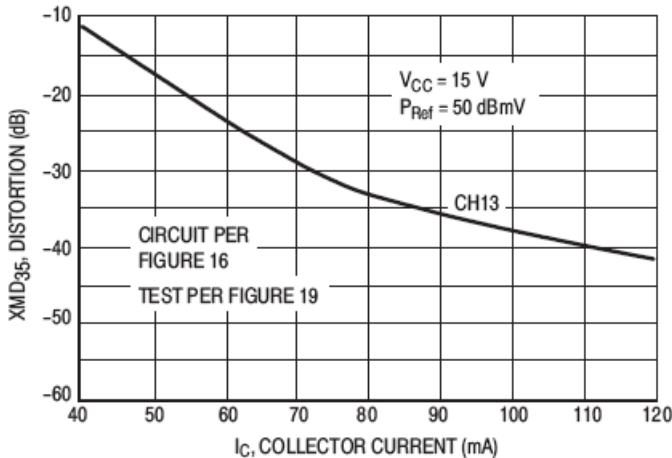


Figure 11. 35-Channel X-Modulation Distortion versus Collector Current

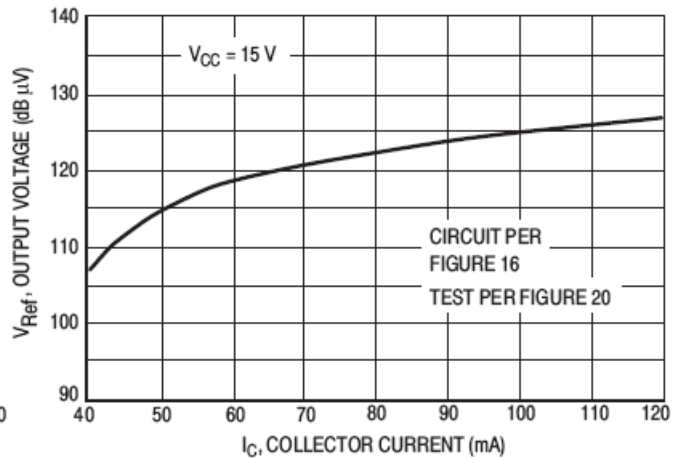


Figure 12. DIN 45004B versus Collector Current

MRF587



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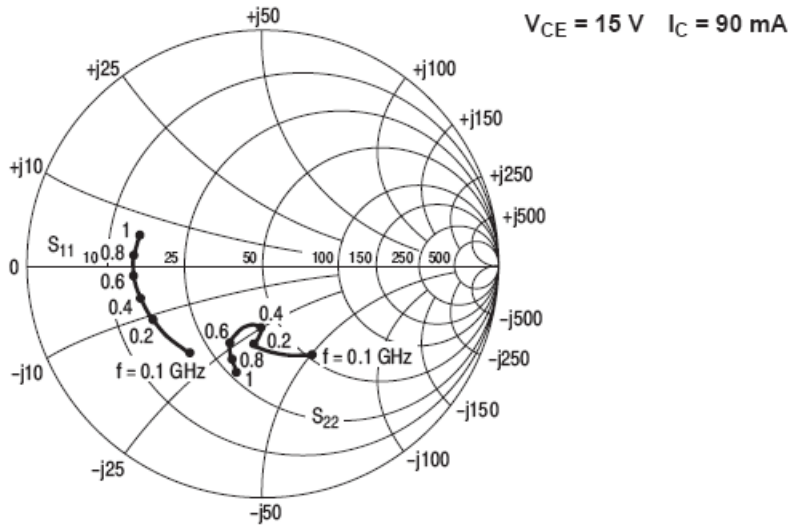


Figure 13. Input/Output Reflection Coefficient versus Frequency (GHz)

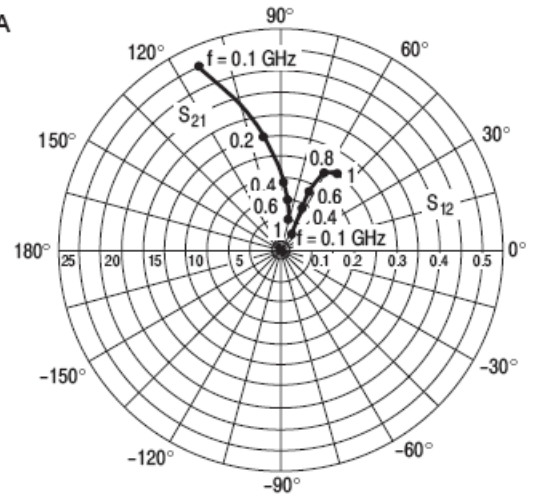


Figure 14. Forward/Reverse Transmission Coefficients versus Frequency (GHz)

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V _{CE} (Volts)	I _C (mA)	f (MHz)	S ₁₁		S ₂₁		S ₁₂		S ₂₂		
			S ₁₁	∠φ	S ₂₁	∠φ	S ₁₂	∠φ	S ₂₂	∠φ	
5.0	30	100	0.56	-131	16.45	113	0.04	45	0.49	-91	
		200	0.58	-159	9.42	98	0.06	49	0.38	-116	
		400	0.60	-178	5.00	86	0.08	55	0.35	-132	
		600	0.64	170	3.61	76	0.11	56	0.38	-138	
		800	0.67	162	2.92	67	0.14	55	0.41	-144	
		1000	0.70	155	2.55	58	0.17	54	0.44	-152	
		60	100	0.53	-141	17.89	110	0.04	50	0.47	-102
	200	0.56	-164	10.05	97	0.05	55	0.39	-126		
	400	0.59	178	5.31	85	0.09	60	0.38	-141		
	600	0.63	169	3.82	76	0.12	59	0.40	-146		
	800	0.66	161	3.09	67	0.15	57	0.44	-153		
	1000	0.69	155	2.67	58	0.18	55	0.47	-160		
	90	100	0.52	-145	18.26	109	0.04	52	0.47	-106	
	200	0.56	-166	10.20	96	0.05	57	0.39	-130		
	400	0.59	177	5.38	85	0.09	62	0.39	-144		
	600	0.63	168	3.86	76	0.12	60	0.41	-149		
	800	0.66	161	3.12	67	0.15	58	0.45	-155		
	1000	0.69	155	2.70	58	0.19	55	0.48	-162		
	10	30	100	0.53	-122	18.36	115	0.04	48	0.50	-75
			200	0.53	-153	10.63	100	0.05	51	0.36	-96
			400	0.55	175	5.71	87	0.08	57	0.33	-112
			600	0.59	173	4.16	78	0.10	58	0.35	-119
			800	0.62	165	3.37	68	0.13	57	0.39	-127
			1000	0.65	158	2.95	59	0.15	55	0.42	-136
60			100	0.49	-132	20.19	112	0.03	51	0.46	-85
200		0.51	-158	11.54	99	0.05	57	0.35	-107		
400		0.53	-178	6.12	87	0.08	61	0.33	-123		
600		0.58	171	4.43	78	0.11	60	0.36	-129		
800		0.60	164	3.58	68	0.14	59	0.40	-136		
1000		0.63	157	3.12	60	0.16	57	0.44	-144		
90		100	0.48	-135	20.82	111	0.03	53	0.45	-88	
200		0.50	-160	11.77	98	0.05	59	0.34	-111		
400		0.53	-179	6.22	86	0.08	63	0.33	-126		
600		0.57	171	4.50	78	0.11	62	0.36	-131		
800		0.60	164	3.64	68	0.14	59	0.41	-139		
1000		0.63	157	3.18	60	0.17	57	0.44	-147		

(continued)

Table 1. Common-Emitter S-Parameters

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			S ₁₁	∠φ	S ₂₁	∠φ	S ₁₂	∠φ	S ₂₂	∠φ
15	30	100	0.49	-112	20.34	118	0.04	54	0.51	-52
		200	0.52	-145	11.51	101	0.05	56	0.36	-77
		400	0.48	-164	6.12	87	0.09	63	0.32	-74
		600	0.52	-174	4.19	75	0.12	62	0.32	-90
		800	0.53	177	3.29	68	0.16	61	0.38	-90
		1000	0.53	168	2.76	61	0.20	56	0.47	-90
	60	100	0.45	-122	22.14	115	0.03	56	0.45	-60
		200	0.49	-150	12.24	99	0.05	60	0.33	-86
		400	0.45	-166	6.45	86	0.09	65	0.30	-83
		600	0.50	-175	4.42	75	0.13	63	0.32	-99
		800	0.51	177	3.47	68	0.16	61	0.38	-98
		1000	0.51	168	2.91	62	0.20	55	0.46	-96
	90	100	0.44	-127	22.76	114	0.03	58	0.43	-62
		200	0.48	-152	12.44	98	0.05	62	0.32	-89
		400	0.44	-167	6.55	85	0.09	66	0.29	-85
		600	0.50	-176	4.47	75	0.13	64	0.32	-102
		800	0.51	176	3.51	69	0.17	61	0.38	-100
		1000	0.51	168	2.95	62	0.20	55	0.46	-98

Table 1. Common-Emitter S-Parameters (continued)

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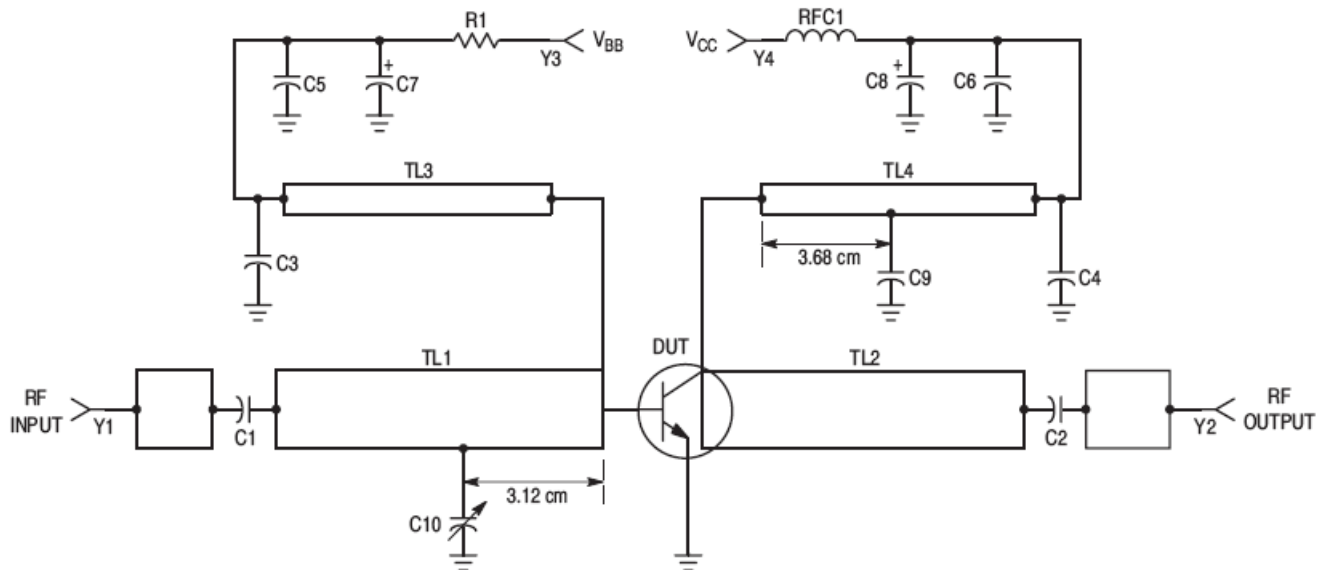
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- C1, C2 — 470 pF Chip (Ceramic)
- C3, C4 — 0.018 μ F Chip Capacitor
- C5, C6 — 0.1 μ F Mylar
- C7, C8 — 1.0 μ F, 25 Vdc Electrolytic
- C9 — 91 pF Mini-Unelco (C9 Taped 3.68 cm from Collector Connection on TL4 as shown)
- C10 — 35–45 pF Johanson Ceramic Capacitor, JMC 5801 or Equivalent (C10 Taped 3.12 cm from Base Connection on TL1)

- R1 — 2.7 k Ω , 1–1/2 W
- RFC1 — 0.15 μ H Molded Choke
- TL1, TL2 — $Z_0 = 26 \Omega$, 0.0625" TFG as shown in Photomaster
- TL3, TL4 — $\lambda/4$ Microstrip, $Z_0 = 100 \Omega$
- Y1, Y2 — N-Type Connection (Female)
- Y3, Y4 — BNC-Type Connector (Female)
- Board Material — 0.0625" Thick Glass Teflon $\epsilon_r = 2.5$

**Figure 15. Narrowband Test Fixture Schematic
500 MHz**

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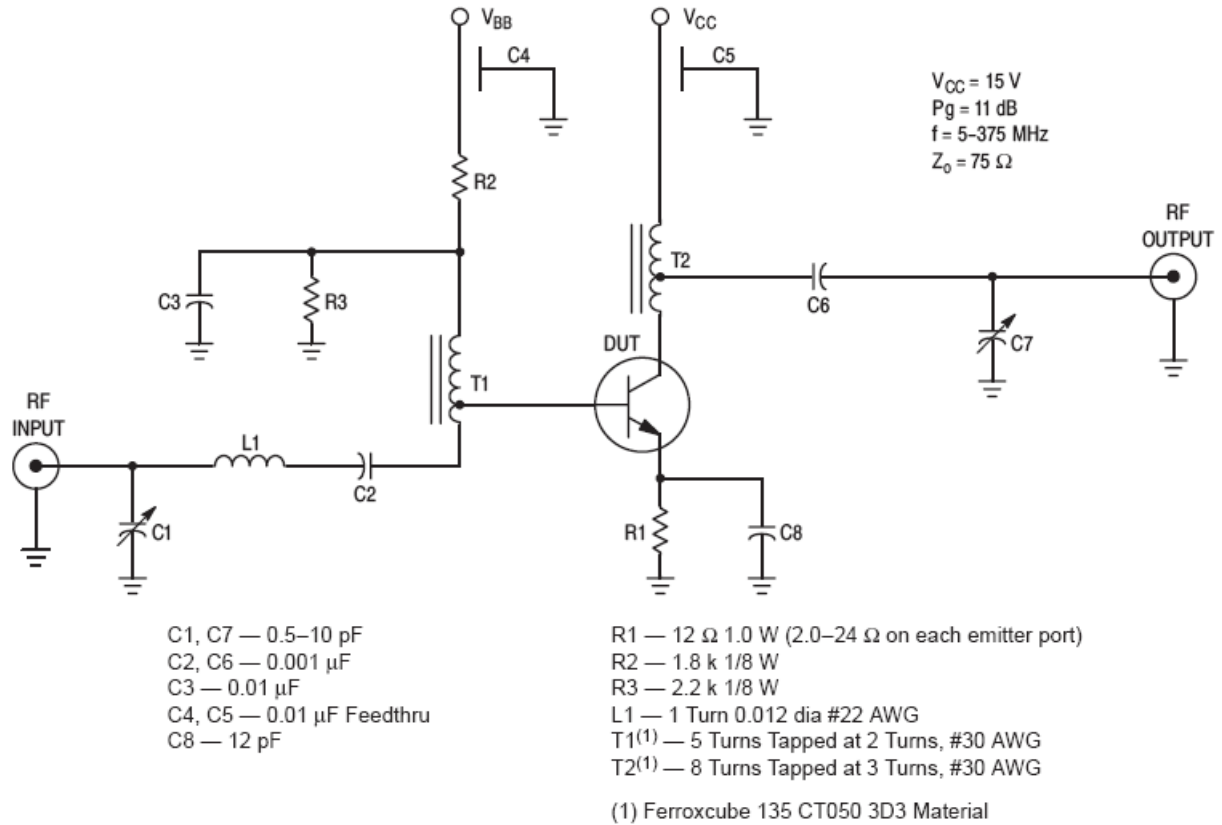


Figure 16. Broadband Test Circuit Schematic

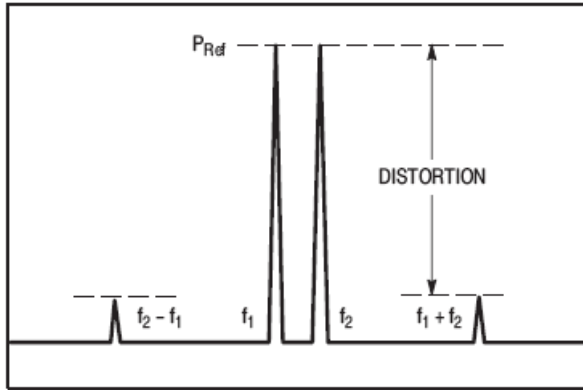


Figure 17. Second Order Distortion Test

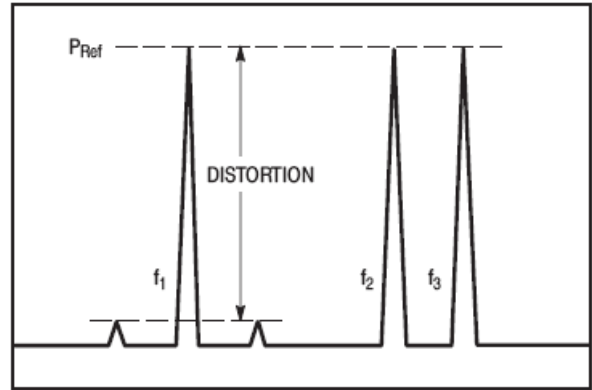


Figure 18. Triple Beat Distortion Test

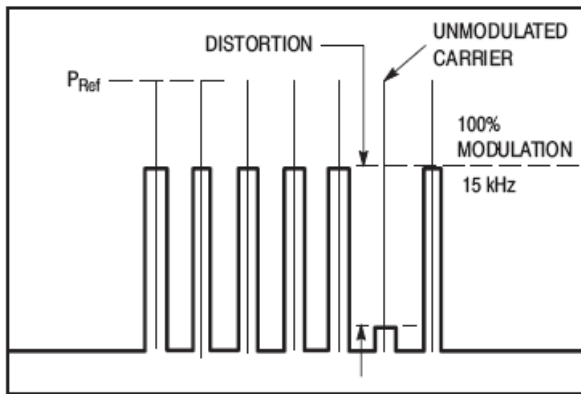


Figure 19. Cross Modulation Distortion Test

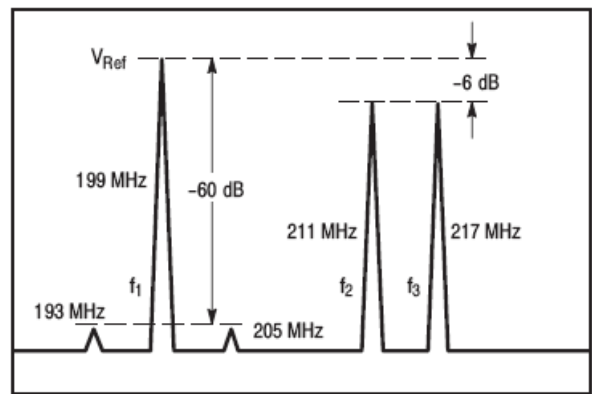


Figure 20. DIN 45004B Intermodulation Test

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PACKAGE DIMENSIONS

